MARKING

DIAGRAMS

Z25 M•



TinyLogic UHS Buffer with Three-State Output

NC7SZ125

Description

The NC7SZ125 is a single buffer with three–state output from onsemi's Ultra–High Speed (UHS) of TinyLogic. The device is fabricated with advanced CMOS technology to achieve ultra high speed with high output drive while maintaining low static power dissipation over a very broad $V_{\rm CC}$ operating range. The device is specified to operate over the 1.65 V to 5.5 V range. The inputs and output are high impedance above ground when $V_{\rm CC}$ is 0 V. Inputs tolerate voltages up to 5.5 V independent of $V_{\rm CC}$ operating voltage. The output tolerates voltages above $V_{\rm CC}$ when in the 3–STATE condition.

Features

- Ultra-High Speed: $t_{PD} = 2.6$ ns (Typical) into 50 pF at 5 V V_{CC}
- High Output Drive: ±24 mA at 3 V V_{CC}
- Broad V_{CC} Operating Range: 1.65 V to 5.5 V
- Matches Performance of LCX when Operated at 3.3 V V_{CC}
- Power Down High-Impedance Inputs / Outputs
- Over-Voltage Tolerance Inputs Facilitate 5 V to 3 V Translation
- Proprietary Noise / EMI Reduction Circuitry
- Ultra−Small MicroPak[™] Packages
- Space-Saving SOT23-5, SC-74A and SC-88A Packages
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant



Figure 1. Logic Symbol

SIP6 CASE 127EB Pin 1 DDKK XYZ Pin 1 DDKK XYZ Pin 1 SC-74A CASE 318BQ 7Z25 M 7Z25 M 7Z25 M

DD, 7Z25, Z25 = Specific Device Code

KK = 2-Digit Lot Run Traceability Code XY = 2-Digit Date Code Format Z = Assembly Plant Code

SC-88A

CASE 419A-02

M = Date CodePb-Free Package

(Microdot may be in either location)

ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 6 of this data sheet.

Pin Configurations

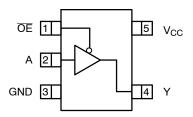


Figure 2. SOT23-5, SC-88A and SC-74A (Top View)

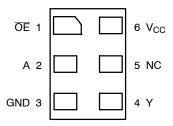


Figure 3. MicroPak (Top Through View)

PIN DEFINITIONS

| Pin # SOT23-5 / SC-88A / SC74A | Pin # MicroPak | Name | Description |
|---|----------------|-----------------|----------------|
| 1 | 1 | ŌĒ | Input |
| 2 | 2 | Α | Input |
| 3 | 3 | GND | Ground |
| 4 | 4 | Υ | Output |
| 5 | 6 | V _{CC} | Supply Voltage |
| | 5 | NC | No Connect |

FUNCTION TABLE

| Inputs | | Output |
|--------|---|--------|
| OE | Α | Υ |
| L | L | L |
| L | Н | Н |
| Н | X | Z |

H = HIGH Logic Level L = LOW Logic Level X = HIGH or LOW Logic Level Z = HIGH Impedance State

ABSOLUTE MAXIMUM RATINGS

| Symbol | Paramet | ter | Min | Max | Unit |
|-------------------------------------|--|------------------------|------|------|------|
| V _{CC} | Supply Voltage | | -0.5 | 6.5 | V |
| V _{IN} | DC Input Voltage | | -0.5 | 6.5 | V |
| V _{OUT} | DC Output Voltage | | -0.5 | 6.5 | V |
| I _{IK} | DC Input Diode Current | V _{IN} < 0 V | - | -50 | mA |
| l _{ok} | DC Output Diode Current | V _{OUT} < 0 V | - | -50 | mA |
| l _{out} | DC Output Current | | - | ±50 | mA |
| I _{CC} or I _{GND} | DC V _{CC} or Ground Current | | - | ±50 | mA |
| T _{STG} | Storage Temperature Range | | -65 | +150 | °C |
| TJ | Junction Temperature Under Bias | | - | +150 | °C |
| TL | Junction Lead Temperature (Solder | ring, 10 Seconds) | - | +260 | °C |
| P_{D} | Power Dissipation in Still Air | SC-74A / SOT23-5 | - | 390 | mW |
| | | SC-88A | - | 332 | |
| | | MicroPak-6 | - | 812 | |
| | | MicroPak2™-6 | - | 812 | |
| ESD | Human Body Model, JEDEC: JESD22-A114 Charge Device Model, JEDEC: JESD22-C101 | | - | 4000 | V |
| | | | - | 2000 | |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

RECOMMENDED OPERATING CONDITIONS

| Symbol | Parameter | Conditions | Min | Max | Unit |
|---------------------------------|---|--|------|-----------------|------|
| V _{CC} | Supply Voltage Operating | | 1.65 | 5.50 | V |
| | Supply Voltage Data Retention | | 1.50 | 5.50 | |
| V _{IN} | Input Voltage | | 0 | 5.5 | V |
| V _{OUT} | Output Voltage | Active State | 0 | V _{CC} | V |
| | | Three-State | 0 | 5.5 | |
| T _A | Operating Temperature | | -40 | +85 | °C |
| t _r , t _f | t _r , t _f Input Rise and Fall Times | V _{CC} at 1.8 V, 2.5 V ±0.2 V | 0 | 20 | ns/V |
| | | V _{CC} at 3.3 V ±0.3 V | 0 | 10 | |
| | | V _{CC} at 5.0 V ±0.5 V | 0 | 5 | |
| $\theta_{\sf JA}$ | Thermal Resistance | SC-74A / SOT23-5 | - | 320 | °C/W |
| | | SC-88A | - | 377 | |
| | | MicroPak-6 | - | 154 | 1 |
| | | MicroPak2-6 | - | 154 | 1 |

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

1. Unused inputs must be held HIGH or LOW. They may not float.

DC ELECTRICAL CHARACTERISTICS

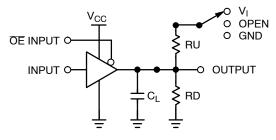
| | | | | T _A = +25°C | | | T _A = -40 to +85°C | |] |
|------------------|--|---------------------|---|------------------------|------|----------------------|-------------------------------|----------------------|------|
| Symbol | Parameter | V _{CC} (V) | Conditions | Min | Тур | Max | Min | Max | Unit |
| V _{IH} | HIGH Level Input Voltage | 1.65 to 1.95 | | 0.65 V _{CC} | - | - | 0.65 V _{CC} | - | V |
| | | 2.30 to 5.50 | | 0.70 V _{CC} | - | - | 0.70 V _{CC} | - | 1 |
| V _{IL} | LOW Level Input Voltage | 1.65 to 1.95 | | - | - | 0.35 V _{CC} | - | 0.35 V _{CC} | ٧ |
| | | 2.30 to 5.50 | | - | - | 0.30 V _{CC} | - | 0.30 V _{CC} | |
| V _{OH} | HIGH Level Output Voltage | 1.65 | $V_{IN} = V_{IH}$ or V_{IL} , | 1.55 | 1.65 | - | 1.55 | - | V |
| | | 1.80 | I _{OH} = -100 μA | 1.70 | 1.80 | - | 1.70 | - | |
| | | 2.30 | | 2.20 | 2.30 | - | 2.20 | - | |
| | | 3.00 | | 2.90 | 3.00 | - | 2.90 | - | |
| | | 4.50 | | 4.40 | 4.50 | - | 4.40 | - | |
| | | 1.65 | I _{OH} = -4 mA | 1.29 | 1.52 | - | 1.29 | - | |
| | | 2.30 | I _{OH} = -8 mA | 1.90 | 2.15 | - | 1.90 | - | |
| | | 3.00 | I _{OH} = -16 mA | 2.40 | 2.80 | - | 2.40 | - | |
| | | 3.00 | I _{OH} = -24 mA | 2.30 | 2.68 | - | 2.30 | - | |
| | | 4.50 | I _{OH} = -32 mA | 3.80 | 4.20 | - | 3.80 | - | |
| V _{OL} | V _{OL} LOW Level Output Voltage | 1.65 | $V_{IN} = V_{IH} \text{ or } V_{IL},$ $I_{OL} = 100 \mu A$ | - | 0.00 | 0.10 | - | 0.00 | V |
| | | 1.80 | | _ | 0.00 | 0.10 | - | 0.10 | |
| | | 2.30 | | - | 0.00 | 0.10 | - | 0.10 | |
| | | 3.00 | | _ | 0.00 | 0.10 | - | 0.10 | |
| | | 4.50 | | _ | 0.00 | 0.10 | - | 0.10 | 1 |
| | | 1.65 | I _{OL} = 4 mA | _ | 0.80 | 0.24 | - | 0.24 | 1 |
| | | 2.30 | I _{OL} = 8 mA | _ | 0.10 | 0.30 | - | 0.30 | 1 |
| | | 3.00 | I _{OL} = 16 mA | _ | 0.15 | 0.40 | - | 0.40 | 1 |
| | | 3.00 | I _{OL} = 24 mA | _ | 0.22 | 0.55 | - | 0.55 | 1 |
| | | 4.50 | I _{OL} = 32 mA | - | 0.22 | 0.55 | - | 0.55 | 1 |
| I _{IN} | Input Leakage Current | 1.65 to 5.5 | $0 \geq V_{IN} \geq 5.5 \ V$ | - | - | ±1 | - | ±10 | μА |
| I _{OZ} | 3-STATE Output Leakage | 0 to 5.5 | $\begin{aligned} V_{IN} &= V_{IH} \text{ or } V_{IL} \\ 0 &\geq V_O \geq 5.5 \text{ V} \end{aligned}$ | - | - | ±1 | _ | ±10 | μΑ |
| I _{OFF} | Power Off Leakage Current | 0 | V _{IN} or V _{OUT} = 5.5 V | - | - | 1 | - | 10 | μΑ |
| Icc | Quiescent Supply Current | 1.65 to 5.50 | V _{IN} = 5.5 V, GND | - | _ | 2 | - | 20 | μΑ |

AC ELECTRICAL CHARACTERISTICS

| | | | | | Γ _A = +25°0 | | T _A = -40 | to +85°C | |
|-------------------------------------|---|------------------------------------|---|---|------------------------|------|----------------------|----------|------|
| Symbol | Parameter | V _{CC} (V) | Conditions | Min | Тур | Max | Min | Max | Unit |
| t _{PLH} , t _{PHL} | Propagation Delay (Figure 4, 6) | 1.65 | C _L = 15 pF, | - | 6.4 | 13.2 | - | 13.8 | ns |
| | | 1.80 | $R_D = 1 M\Omega$ $S_1 = OPEN$ | - | 5.3 | 11.0 | - | 11.5 | |
| | | 2.50 ±0.20 | 1 | - | 3.4 | 7.5 | - | 8.0 | |
| | | 3.30 ±0.30 | 1 | - | 2.5 | 5.2 | - | 5.5 | |
| | | 5.00 ±0.50 | 1 | - | 2.1 | 4.5 | - | 4.8 | |
| | | 3.30 ±0.30 C _L = 50 pF, | - | 3.2 | 5.7 | - | 6.0 | | |
| | | 5.00 ±0.50 | $R_D = 500 \Omega$ $S_1 = OPEN$ | - | 2.6 | 5.0 | - | 5.3 | |
| t _{PZL} , t _{PZH} | (Figure 4, 6) $ \begin{array}{c c} R_D = 500 \ \Omega \\ RU = 500 \ \Omega \\ S_1 = GND \ for \end{array} $ | C _L = 50 pF, | - | 8.4 | 15.0 | - | 15.6 | ns | |
| | | 1.80 | $RU = 500 \Omega$ | - | 7.0 | 12.5 | - | 13.0 | |
| | | | 2.50 ±0.20 | $S_1 = GND \text{ for } t_{PZH}$ $S_1 = V_{IN} \text{ for } t_{PZL}$ | - | 4.6 | 8.5 | - | 9.0 |
| | | 3.30 ±0.30 | $V_{IN} = 2 \cdot V_{CC}$ | - | 3.5 | 6.2 | - | 6.5 | |
| | | 5.00 ±0.50 |] | _ | 2.8 | 5.5 | - | 5.8 | |
| t _{PLZ} , t _{PHZ} | Output Disable Time | 1.65 | C _L = 50 pF, | _ | 6.5 | 13.2 | - | 14.5 | |
| | (Figure 4, 6) | 1.80 | R_D = 500 Ω RU = 500 Ω | _ | 5.4 | 11.0 | - | 12.0 | |
| | | 2.50 ±0.20 | $S_1 = GND \text{ for } t_{PHZ}$ $S_1 = V_{IN} \text{ for } t_{PLZ}$ | _ | 3.5 | 8.0 | - | 8.5 | |
| | | 3.30 ±0.30 | $V_{IN} = 2 \cdot V_{CC}$ | _ | 2.8 | 5.7 | - | 6.0 | |
| | | 5.00 ±0.50 | 1 | - | 2.1 | 4.7 | - | 5.0 | |
| C _{IN} | Input Capacitance | 0.00 | | ı | 4 | - | - | _ | pF |
| C _{OUT} | Output Capacitance | 0.00 | | ı | 8 | - | - | _ | |
| C _{PD} | Power Dissipation Capacitance (Note 2) (Figure 5) | 3.30 | | - | 17 | - | - | _ | pF |

^{2.} C_{PD} is defined as the value of the internal equivalent capacitance which is derived from dynamic operating current consumption (I_{CCD}) at no output loading and operating at 50% duty cycle. C_{PD} is related to I_{CCD} dynamic operating current by the expression:

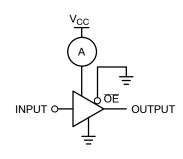
I_{CCD} = (C_{PD}) (V_{CC}) (f_{IN}) + (I_{CC}static).



NOTE:

3. C_L includes load and stray capacitance; Input PRR = 1.0 MHz; t_W = 500 ns

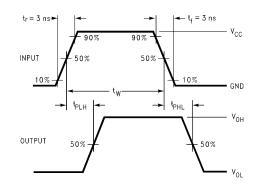
Figure 4. AC Test Circuit



NOTE:

4. Input = AC Waveform; $t_r = t_f = 1.8 \text{ ns}$; PRR = 10 MHz; Duty Cycle = 50%.

Figure 5. I_{CCD} Test Circuit



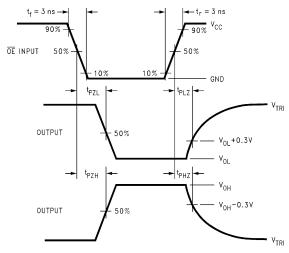


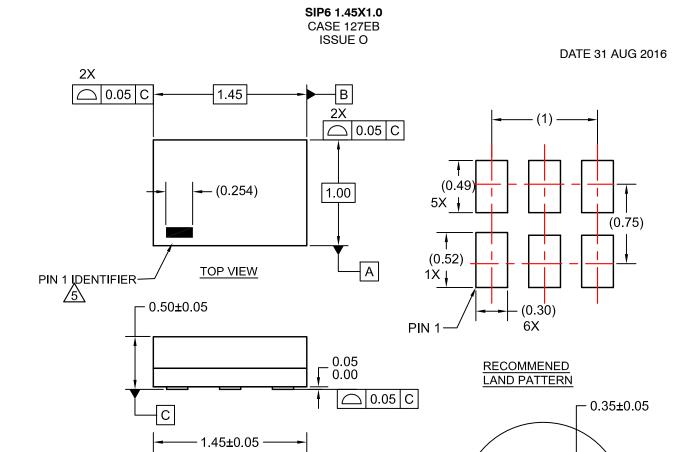
Figure 6. AC Waveforms

ORDERING INFORMATION

| Part Number | Top Mark | Operating Temperature | Packages | Shipping [†] |
|--------------------|----------|-----------------------|-----------|-----------------------|
| NC7SZ125M5X | 7Z25 | −40 to +85°C | SC-74A | 3000 / Tape & Reel |
| NC7SZ125M5X-L22090 | 7Z25 | −40 to +85°C | SOT23-5 | 3000 / Tape & Reel |
| NC7SZ125P5X | Z25 | −40 to +85°C | SC-88A | 3000 / Tape & Reel |
| NC7SZ125P5X-F22057 | Z25 | −40 to +85°C | SC-88A | 3000 / Tape & Reel |
| NC7SZ125L6X | DD | −40 to +85°C | MicroPak | 5000 / Tape & Reel |
| NC7SZ125L6X-L22175 | DD | −40 to +85°C | MicroPak | 5000 / Tape & Reel |
| NC7SZ125FHX | DD | −40 to +85°C | MicroPak2 | 5000 / Tape & Reel |
| NC7SZ125FHX-L22175 | DD | −40 to +85°C | MicroPak2 | 5000 / Tape & Reel |

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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0.20±0.05 6X

0.10(M)0.05(M)

0.30±0.05 5X

0.35±0.05 5X

(0.125)

4X

C B A

0.075 X 45°

CHAMFER

NOTES:

DETAIL A

1.00±0.05

(0.050)

6X

1. CONFORMS TO JEDEC STANDARD MO-252 VARIATION UAAD

0.5

1.0

- 2. DIMENSIONS ARE IN MILLIMETERS
- 3. DRAWING CONFORMS TO ASME Y14.5M-2009
 4. PIN ONE IDENTIFIER IS 2X LENGTH OF ANY

BOTTOM VIEW

- - OTHER LINE IN THE MARK CODE LAYOUT.

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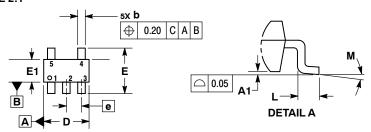
0.40±0.05

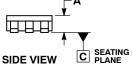
PIN 1 TERMINAL

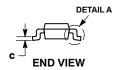
DETAIL A



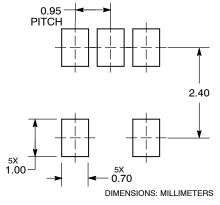
DATE 18 JAN 2018











*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

NOTES:

- DIMENSIONING AND TOLERANCING PER ASME
 Y14.5M, 1994.
 CONTROLLING DIMENSION: MILLIMETERS.
 MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH
 THICKNESS. MINIMUM LEAD THICKNESS IS THE
 MINIMUM THICKNESS OF BASE MATERIAL.
- DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.15 PER SIDE.

| | MILLIMETERS | | | |
|-----|-------------|------|--|--|
| DIM | MIN | MAX | | |
| Α | 0.90 | 1.10 | | |
| A1 | 0.01 | 0.10 | | |
| b | 0.25 | 0.50 | | |
| С | 0.10 | 0.26 | | |
| D | 2.85 | 3.15 | | |
| E | 2.50 | 3.00 | | |
| E1 | 1.35 | 1.65 | | |
| е | 0.95 BSC | | | |
| L | 0.20 | 0.60 | | |
| М | 0 ° | 10° | | |

GENERIC MARKING DIAGRAM*



XXX = Specific Device Code

Μ = Date Code = Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ", may or may not be present. Some products may not follow the Generic Marking.

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SC-88A (SC-70-5/SOT-353) CASE 419A-02 **ISSUE L**

DATE 17 JAN 2013



- TIES:
 DIMENSIONING AND TOLERANCING
 PER ANSI Y14.5M, 1982.
 CONTROLLING DIMENSION: INCH.
 419A-01 OBSOLETE. NEW STANDARD 3.
- 419A-02.
 DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

| | INC | HES | MILLIMETER | |
|-----|-----------|-------|------------|------|
| DIM | MIN | MAX | MIN | MAX |
| Α | 0.071 | 0.087 | 1.80 | 2.20 |
| В | 0.045 | 0.053 | 1.15 | 1.35 |
| С | 0.031 | 0.043 | 0.80 | 1.10 |
| D | 0.004 | 0.012 | 0.10 | 0.30 |
| G | 0.026 | BSC | 0.65 BSC | |
| Н | | 0.004 | | 0.10 |
| J | 0.004 | 0.010 | 0.10 | 0.25 |
| K | 0.004 | 0.012 | 0.10 | 0.30 |
| N | 0.008 REF | | 0.20 | REF |
| S | 0.079 | 0.087 | 2.00 | 2.20 |

GENERIC MARKING DIAGRAM*



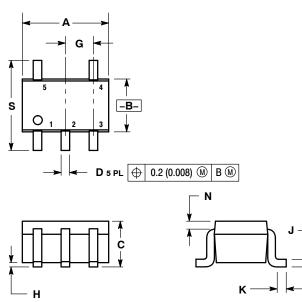
XXX = Specific Device Code

= Date Code

= Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.



| | | | 0.65 0.025 |
|------|----------------------|------------|--|
| 0.40 | | | 0.65 0.025 |
| _ | <u>1.9</u> 0.0748 | SCALE 20:1 | $\left(\frac{\text{mm}}{\text{inches}}\right)$ |

SOLDER FOOTPRINT

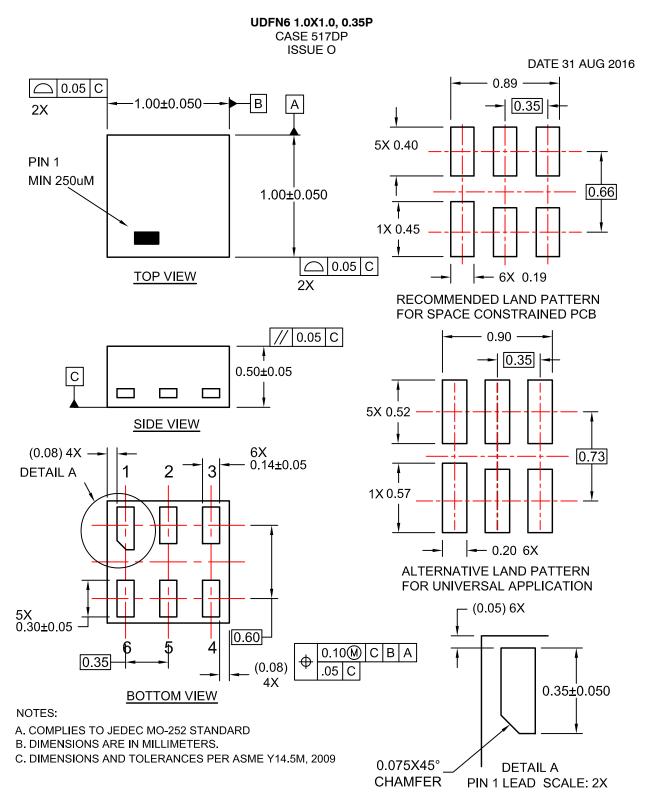
0.50

| STYLE 1: PIN 1. BASE 2. EMITTER 3. BASE 4. COLLECTOR 5. COLLECTOR | STYLE 2: PIN 1. ANODE 2. EMITTER 3. BASE 4. COLLECTOR 5. CATHODE | STYLE 3: PIN 1. ANODE 1 2. N/C 3. ANODE 2 4. CATHODE 2 5. CATHODE 1 | STYLE 4: PIN 1. SOURCE 1 2. DRAIN 1/2 3. SOURCE 1 4. GATE 1 5. GATE 2 | STYLE 5: PIN 1. CATHODE 2. COMMON ANODE 3. CATHODE 2 4. CATHODE 3 5. CATHODE 4 |
|--|--|--|--|--|
| 5. COLLECTOR | 5. CATHODE | 5. CATHODE 1 | 5. GATE 2 | 5. CATHODE 4 |

| 5. COLLECTOR | 5. CATHODE | 5. CATHODE 1 | 5. GATE 2 | 5. CATHODE 3 |
|--|--|--|--|---|
| STYLE 6: PIN 1. EMITTER 2 2. BASE 2 3. EMITTER 1 4. COLLECTOR 5. COLLECTOR 2/BASE 1 | STYLE 7: PIN 1. BASE 2. EMITTER 3. BASE 4. COLLECTOR 5. COLLECTOR | STYLE 8: PIN 1. CATHODE 2. COLLECTOR 3. N/C 4. BASE 5. EMITTER | STYLE 9: PIN 1. ANODE 2. CATHODE 3. ANODE 4. ANODE 5. ANODE | Note: Please refer to datasheet for style callout. If style type is not called out in the datasheet refer to the device datasheet pinout or pin assignment. |

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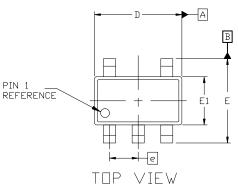


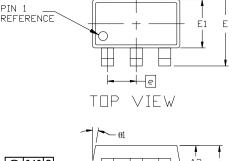
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| DESCRIPTION: | UDFN6 1.0X1.0, 0.35P | | PAGE 1 OF 1 | |

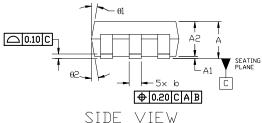
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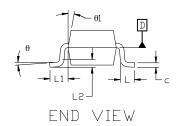












GENERIC MARKING DIAGRAM*



XXX = Specific Device Code = Date Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "=", may or may not be present. Some products may not follow the Generic Marking.

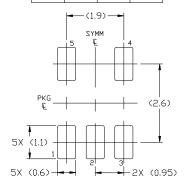
SOT-23, 5 Lead CASE 527AH **ISSUE A**

DATE 09 JUN 2021

NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 19894
- CONTROLLING DIMENSION: MILLIMETERS
- MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF THE
- DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS, MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.25 PER SIDE. D AND E1 DIMENSIONS ARE DETERMINED AT DATUM D.
- DIMENSION 'b' DOES NOT INCLUDE DAMBAR PROTRUSION. DAMBAR PROTRUSION SHALL BE O. 08mm TOTAL IN EXCESS OF THE 'b' DIMENSION AT MAXIMUM MATERIAL CONDITION. MINIMUM SPACE BETWEEN PROTRUSION AND AN ADJACENT LEAD SHALL NOT BE LESS THAN 0.07mm.

| | MILLIMETERS | | |
|-----|-------------|------|------|
| DIM | MIN. | N□M. | MAX. |
| Α | 0.90 | _ | 1.45 |
| A1 | 0.00 | _ | 0.15 |
| A2 | 0.90 | 1.15 | 1.30 |
| b | 0.30 | _ | 0.50 |
| C | 0.08 | _ | 0.22 |
| D | 2.90 BSC | | |
| Ε | 2.80 BSC | | |
| E1 | 1.60 BSC | | |
| е | 0.95 BSC | | |
| L | 0.30 | 0.45 | 0.60 |
| L1 | 0.60 REF | | |
| L2 | 0.25 REF | | |
| θ | 0° | 4° | \$ |
| θ1 | 0° | 10° | 15° |
| θ2 | 0° | 10° | 15° |



RECOMMENDED MOUNTING FOOTPRINT

For additional information on our Pb-Free strategy and soldering details, please download the $\square N$ Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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|------------------|----------------|---|-------------|--|
| DESCRIPTION: | SOT-23, 5 LEAD | | PAGE 1 OF 1 | |

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